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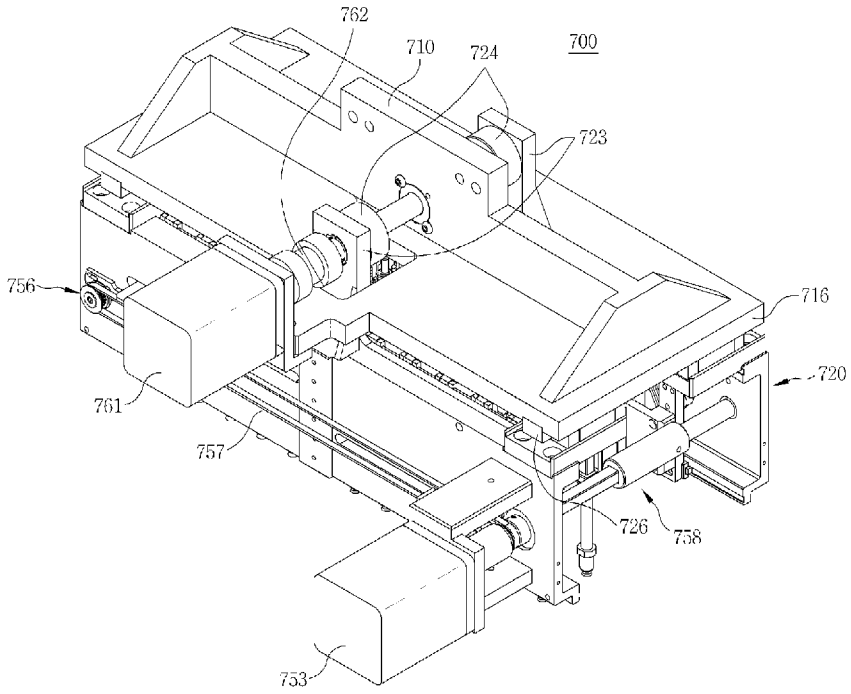
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(54) **Title:** TOOL FOR TRANSFERRING SEMICONDUCTOR DEVICE

[Fig. 3]



(57) **Abstract:** A tool for transferring a semiconductor device capable of picking up an object to be transferred such as a semiconductor device for transferring. The tool for transferring semiconductor devices, comprises: a supporting bracket movably installed at a transfer tool guide; and pickers installed at the supporting bracket in a plurality of rows, for picking up semiconductor devices.

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